

# **Epoxy Resin Systems Epoxy adhesives**

# **WEICON Easy-Mix HT** 180 Epoxy Adhesive



# High temperature resistance |steady | shock- and impact resistant

WEICON Easy-Mix HT 180 is a 2-component adhesive based on epoxy resin with high temperature resistance up to +180 °C (+356 °F); short-term up to +230 °C (+446 °F). The adhesive is highly viscous and stable which also makes it suitable for vertical applications. It is impact- and shock-resistant, has a long pot life, cures at room temperature and is machinable after curing. The adhesive is particularly suitable for the bonding of composite materials and metal and can be spotwelded while curing. Easy-Mix HT 180 can also be used on plastics, ceramics, glass, stone or wood and is suitable for adhesions where larger tolerances have to be bridged. Due to special fillers, it is possible to achieve a non-varying and reliable adhesive joint of at least 0.20 - 0.25 mm. The high temperature resistance enables the bonding of components, which are thermo-coated (powder-coated) after curing.

## Characteristics

Base		Epoxy resin, mineral- filled
Texture		pasty, gap-filling
Colour		black
Minimum shelf life	at room temperature	24 mon.
Processing		
Processing temperature		+10 °C to +40 °C
Curing temperature		+10 °C - +50 °C
Mixing ratio by weight		2:1
Density of the mixture		1,1 g/cm <sup>3</sup>
Gap bridging up to max.		4 mm
Curing		
Pot life	at 20 °C, 10 ml batch	60 min.
Handling strength	(35 % strength)	120 min.
Working strength after	(50 % strength)	4 h
Final strength	(100 % strength)	24 h
Shrinkage		0,3 %

# Mechanical properties after curing

3		
E-modulus (tensile)	DIN EN ISO 527-2	2.300 - 2.700 MPa
Compressive strength	DIN EN ISO 604	52 MPa
Bending strength	DIN EN ISO 178	46 MPa
Hardness (Shore D)	DIN ISO 7619	80
Lap shear strength material t	hickn. 1,5mm DIN EN 1465	
Steel 1.0338 sandblasted		23 N/mm <sup>2</sup>
Stainless steel V2A sandblasted		24 N/mm <sup>2</sup>
Aluminium sandblasted		13 N/mm <sup>2</sup>
Galvanized steel		8 N/mm <sup>2</sup>
PVC-rigid roughened		11 N/mm <sup>2</sup>
CFRP		22 N/mm²

**DIN EN ISO 527-2** 

#### Thermal parameters

Temperature resistance		-50 °C to 180 °C, briefly up to +230 °C
Tg after curing at room temperature	(DSC)	54,4 °C
Tg after tempering (at 120°C)	(DSC)	44,7 °C
Temperature conductivity		0,172 mm <sup>2</sup> /s
Thermal conductivity	DIN EN ISO 22007-4	0,26 W/m·K
Heat capacity	DIN EN ISO 22007-4	1,335 J/(g·K)
Electrical parameters		
Resistance	DIN EN 62631-3-1	2,48 · 10 <sup>11</sup> Ω·m
Dielectric strength	DIN EN 60243-1 (20°C)	18 kV/mm
Approvals / Guidelines		
ISSA Code		75.530.04
IMPA Code		812923
MIL-Spec	complies with	MIL-A-47284A

## Instructions for use

When using WEICON products, the physical, safety-related, toxicological and ecological data and regulations in our EC safety data sheets (www.weicon.com) must be observed.

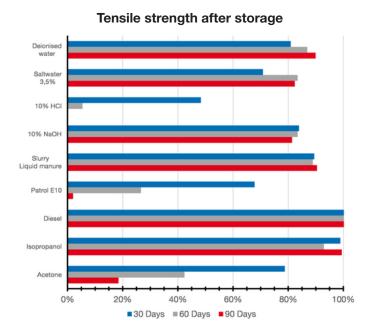
The specifications and recommendations given in this technical data sheet must not be seen as guaranteed product characteristics. They are based on our laboratory tests and on practical experience. Since individual application conditions are beyond our knowledge, control and responsibility, this information is provided without any obligation. We do guarantee the continuously high quality of our products. However, own adequate laboratory and practical tests to find out if the product in question meets the requested properties are recommended. A claim cannot be derived from them. The user bears the requested properties are recommended. A claim cannot be derived from them.

# M E I C O U

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# **Surface Pre-Treatment**

Clean and dry bonding surfaces are essential for flawless adhesive bonding (e.g. cleaning and degreasing with WEICON Surface Cleaner).

# **Application**

WEICON Easy-Mix products can be processed straight from the double cartridge by means of the included static mixer. Dismiss the first 5 cm of the adhesive bead. The adhesive is applied to just one side. The specified pot life refers to a material batch of 10 ml at room temperature. Larger batch quantities will result in faster curing. Higher temperatures also reduce the pot life and curing time. (General rule: every increase by +10 °C above room temperature results in a decrease of the pot life and curing time by half). Temperatures below +16 °C increase the pot life and curing time significantly. From approx. +5 °C and below, no reaction takes place.

# **Storage**

WEICON epoxy adhesives should be stored in a dry place at room temperature. Unopened containers can be stored at temperatures from +18 °C to +25 °C. Protect from direct sunlight. Failure to observe these storage instructions will reduce the shelf life to 6 months. Epoxy resins generally tend to crystallise at temperatures below +5 °C. This effect is increased by large temperature fluctuations, e.g. during transport especially in the winter months. This has a negative impact on processing, curing and technical data, can, however, be reversed by heating the product (up to max. +50 °C, no open flame). In WEICON epoxy adhesives, crystallisation is reduced by the careful choice and combination of base resins (bisphenol A and F).

# Scope of delivery

Adhesive | Helix Mixing Nozzle A

# **Accessories**

10005237 Dispenser Easy-Mix D 50, 1 PCE
 10101999 WEICON Manual Dispenser, 1 x 1:1 | 2:1
 10026925 Helix Mixing Nozzle A, 1 PCE, white

## **Conversion table**

 $(^{\circ}C \times 1.8) + 32 = ^{\circ}F$  Nm x 8.851 = lb·in mm/25.4 = inch Nm x 0.738 = lb·ft µm/25.4 = mil Nm x 141.62 = oz·in N x 0.225 = lb mPa·s = cP N/mm² x 145 = psi N/cm x 0.571 = lb/in MPa x 145 = psi kV/mm x 25.4 = V/mil

## **Available sizes**

10044884 WEICON Easy-Mix HT 180 Epoxy Adhesive, 50 ml, black

page:



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